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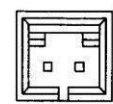
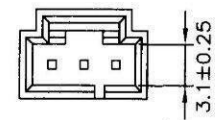
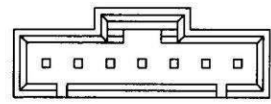
H

H

(4P~18P)

(3P)

(2P)



NOTES

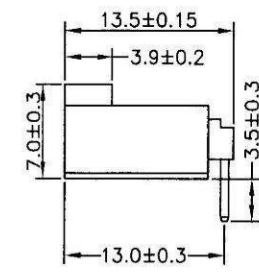
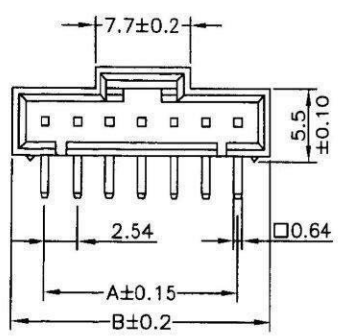
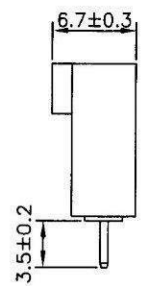
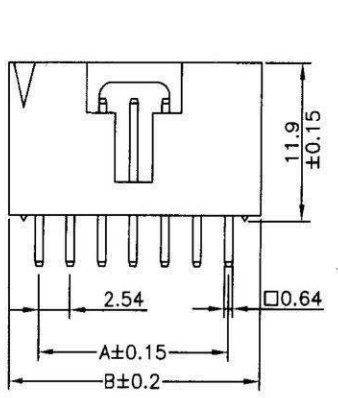
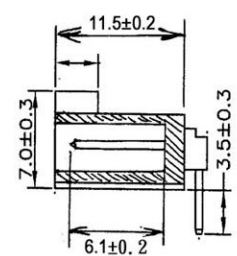
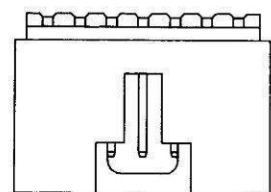
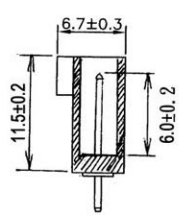
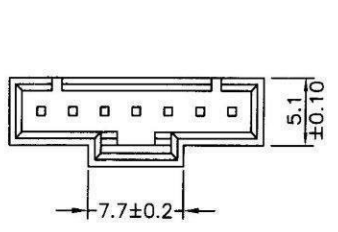
- \* Poles:2-18
- \* Material:Insulator:PBT UL94V-0 BLACK
- \* Contact:0.64mm(.025") square pin,brass, (gold plated or Tin plated)

Specifications

- \* Current rating: 2.5A AC, DC
- \* Voltage rating: 250V AC, DC
- \* Temperature range: -25°C~+85°C
- \* Insulation resistance: 1,000MΩ min.
- \* Withstand voltage: 600 AC/minute
- \* Applicable PC board thickness: .063" (1.6mm)
- \* Endure under max. 240°C 5SECS.

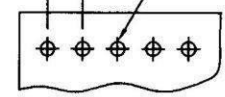
P/N: W7166-XXPS(G,T)B00R

P/N: W7166-XXPR(G,T)B00R



CIRCUITS	DIMENSION mm	
	A	B
2	2.54	7.62
3	5.08	10.16
4	7.62	12.70
5	10.16	15.24
6	12.70	17.78
7	15.24	20.32
8	17.78	22.86
9	20.32	25.40
10	22.86	27.94
11	25.40	30.48
12	27.94	33.02
13	30.48	35.56
14	33.02	38.10
15	35.56	40.64
16	38.10	43.18
17	40.64	45.72
18	43.18	48.26

2.54 ± 0.08      ø1.09 ± 0.08



P.C. Board Layout

RoHS Compliant

HSM 玄茂科技股份有限公司  
HSUAN MAO TECHNOLOGY CO., LTD.

APPD. 核准  
DWG. 製圖 Helen  
DATE 制表日 2012/12/12

SCALE 比例 參考  
UNIT 單位 MM  
PAGE 張數 1 OF 1

TOLERANCE  
X. ±0.5  
X.X ±0.25  
X.XX ±0.2  
X.XXX ±0.08

SIZE 紙張尺寸 A4  
REV. 版本 A

PART NAME 品名  
CD ROM 2.54mm XXP W/O LOCATING PEG  
BLACK COLOR

PART NO.  
料號 W7166-XXPXXB00R

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